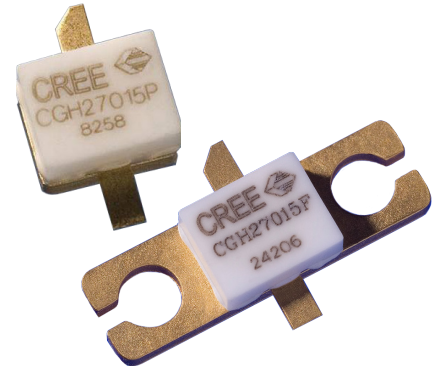


CGH27015

15 W, 28 V, GaN HEMT for Linear Communications
ranging from VHF to 3 GHz

Description

Cree's CGH27015 is a gallium nitride (GaN) high electron mobility transistor designed specifically for high efficiency, high gain and wide bandwidth capabilities, which makes the CGH27015 ideal for VHF, Comms, 3G, 4G, LTE, 2.3-2.9 GHz WiMAX and BWA amplifier applications. The unmatched transistor is available in both screw-down, flange and solder-down, pill packages.



Package Types: 440166 and 440196
PNs: CGH27015F and CGH27015P

Typical Performance Over 2.3-2.7 GHz ($T_c = 25^\circ\text{C}$)

Parameter	2.3 GHz	2.4 GHz	2.5 GHz	2.6 GHz	2.7 GHz	Units
Small Signal Gain	16.9	16.0	15.1	14.6	14.3	dB
EVM at $P_{AVE} = 33\text{ dBm}$	1.69	1.51	1.50	1.66	1.93	%
Drain Efficiency at $P_{AVE} = 33\text{ dBm}$	27.1	27.8	28.4	28.0	28.0	dB

Note: Measured in the CGH27015F-AMP amplifier circuit, under 802.16 OFDM, 3.5 MHz Channel BW, 1/4 Cyclic Prefix, 64 QAM Modulated Burst, 5 ms Burst, Symbol Length of 59, Coding Type RS-CC, Coding Rate Type 2/3, PAR = 9.8 dB @ 0.01 % Probability on CCDF.

Features

- VHF - 3.0 GHz Operation
- 15 W Peak Power Capability
- 14.5 dB Small Signal Gain
- 2 W $P_{AVE} < 2.0\%$ EVM
- 28% Efficiency at 2 W Average Power
- Designed for WiMAX Fixed Access 802.16-2004 OFDM Applications
- Designed for WiMAX Mobile Access 802.16e OFDMA Applications

 Large Signal Models Available for ADS and MWO

RoHS
COMPLIANT

Absolute Maximum Ratings (not simultaneous) at 25 °C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	V_{DS}	120	Volts	25 °C
Gate-to-Source Voltage	V_{GS}	-10, +2	Volts	25 °C
Storage Temperature	T_{STG}	-65, +150	°C	
Operating Junction Temperature	T_J	225	°C	
Maximum Forward Gate Current	I_{GMAX}	4.0	mA	25 °C
Maximum Drain Current ¹	I_{DMAX}	1.5	A	25 °C
Soldering Temperature ²	T_S	245	°C	
Screw Torque	τ	40	in-oz	
Thermal Resistance, Junction to Case ³	$R_{\theta JC}$	8.0	°C/W	85 °C
Case Operating Temperature ³	T_C	-40, +150	°C	

Notes:

¹ Current limit for long term, reliable operation

² Refer to the Application Note on soldering at wolfspeed.com/RF/Document-Library

³ Measured for the CGH27015F at $P_{DISS} = 14W$

Electrical Characteristics ($T_C = 25^\circ C$)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics¹						
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	V_{DC}	$V_{DS} = 10 V, I_D = 3.6 mA$
Gate Quiescent Voltage	$V_{GS(Q)}$	–	-2.7	–	V_{DC}	$V_{DS} = 28 V, I_{DQ} = 100 mA$
Saturated Drain Current	I_{DS}	2.9	3.5	–	A	$V_{DS} = 6.0 V, V_{GS} = 2.0 V$
Drain-Source Breakdown Voltage	V_{BR}	84	–	–	V_{DC}	$V_{GS} = -8 V, I_D = 3.6 mA$
RF Characteristics^{2,3} ($T_C = 25^\circ C, F_0 = 2.5 GHz$ unless otherwise noted)						
Small Signal Gain	G_{SS}	13	15	–	dB	$V_{DD} = 28 V, I_{DQ} = 100 mA$
Drain Efficiency ⁴	η	20	28	–	%	$V_{DD} = 28 V, I_{DQ} = 100 mA, P_{AVE} = 33 dBm$
Error Vector Magnitude	EVM	–	2.0	–	%	$V_{DD} = 28 V, I_{DQ} = 100 mA, P_{AVE} = 33 dBm$
Output Mismatch Stress	VSWR	–	–	10 : 1	Y	No damage at all phase angles, $V_{DD} = 28 V, I_{DQ} = 100 mA,$ $P_{AVE} = 33 dBm$ OFDM P_{AVE}
Dynamic Characteristics						
Input Capacitance	C_{GS}	–	4.5	–	pF	$V_{DS} = 28 V, V_{GS} = -8 V, f = 1 MHz$
Output Capacitance	C_{DS}	–	1.3	–	pF	$V_{DS} = 28 V, V_{GS} = -8 V, f = 1 MHz$
Feedback Capacitance	C_{GD}	–	0.2	–	pF	$V_{DS} = 28 V, V_{GS} = -8 V, f = 1 MHz$

Notes:

¹ Measured on wafer prior to packaging

² Measured in the CGH27015F-AMP test fixture

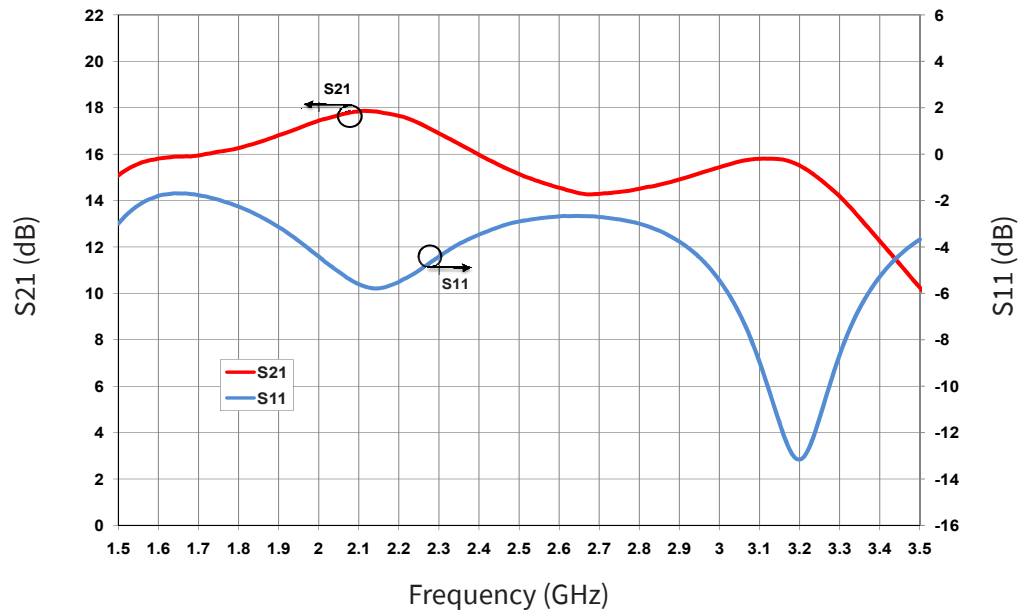
³ Under 802.16 OFDM, 3.5 MHz Channel BW, 1/4 Cyclic Prefix, 64 QAM Modulated Burst, 5 ms Burst, Symbol Length of 59, Coding Type RS-CC, Coding Rate

⁴ Drain Efficiency = P_{OUT} / P_{DC}

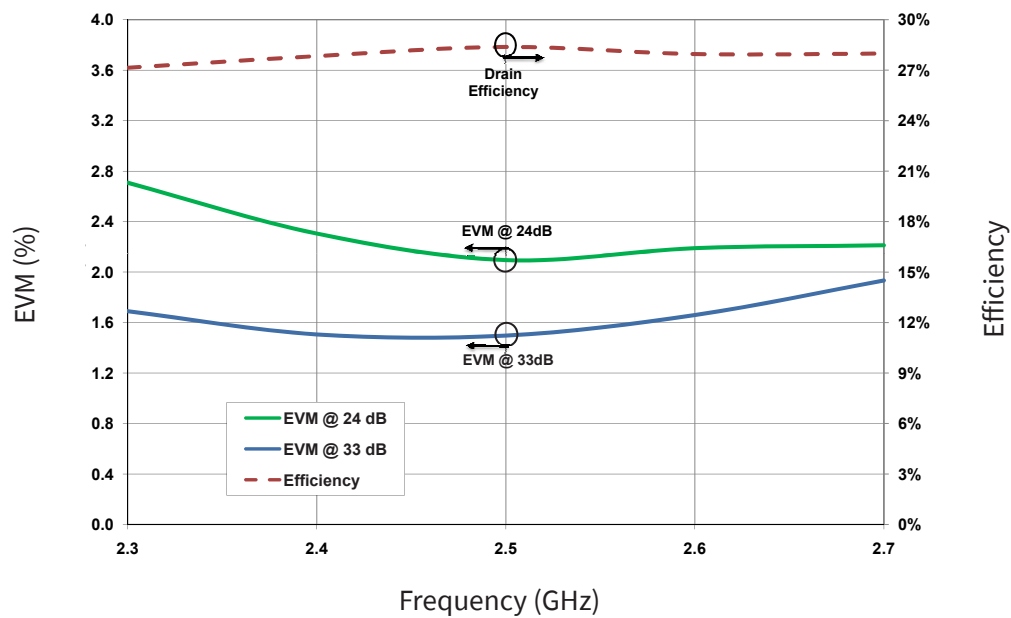
Typical Performance Data

Performance of CGH27015 in Broadband Amplifier Circuit

$$V_{DD} = 28 \text{ V}, I_{DQ} = 100 \text{ mA}$$



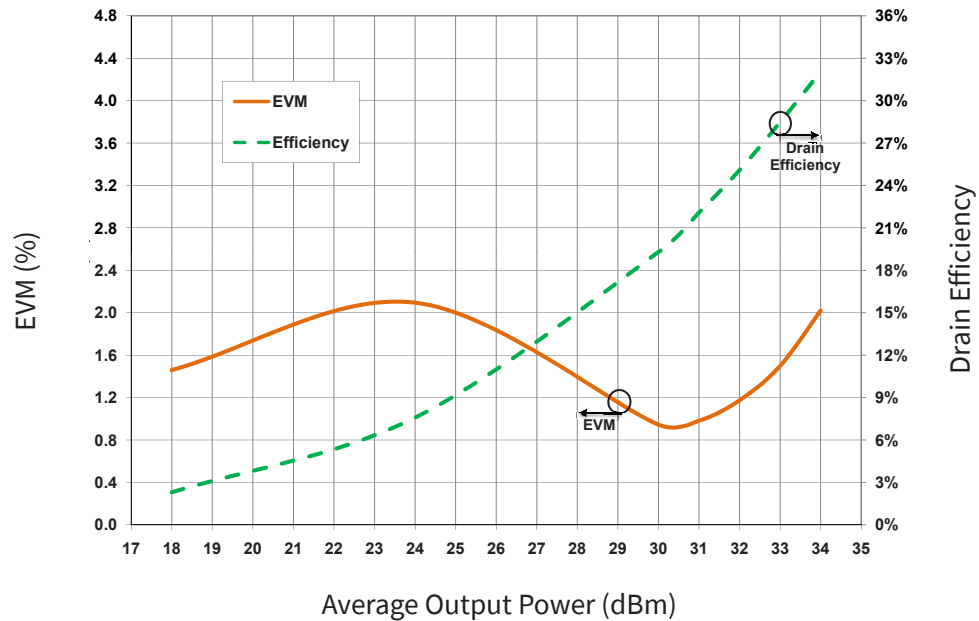
Typical EVM and Efficiency at 24dB and 33 dB vs Frequency of CGH27015 in Broadband Amplifier Circuit



Note: Under 802.16 OFDM, 3.5 MHz Channel BW, 1/4 Cyclic Prefix, 64 QAM Modulated Burst, Symbol Length of 59, Coding Type RS-CC, Coding Rate Type 2/3.

Typical Performance Data

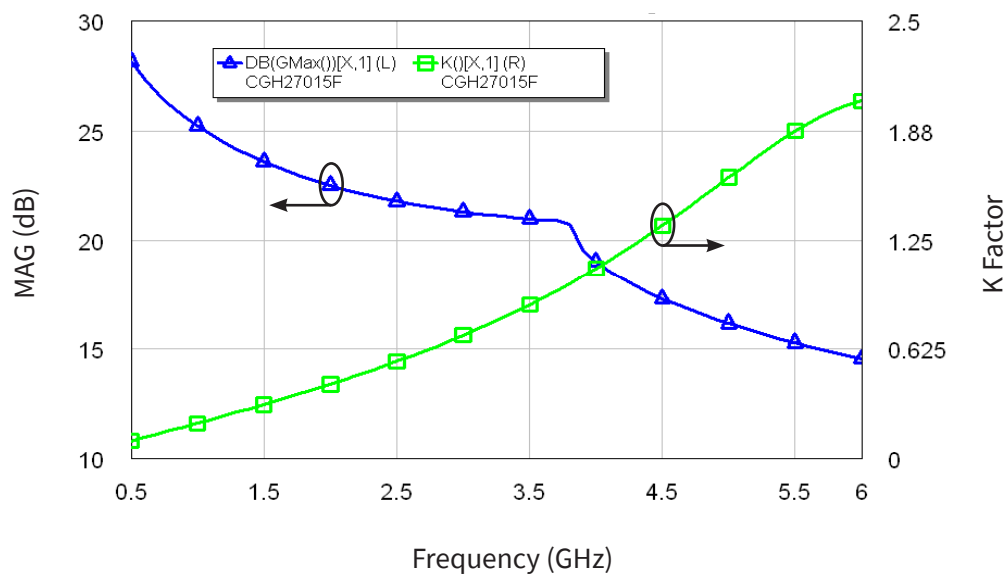
Typical EVM and Efficiency of CGH27015 in Broadband Amplifier Circuit at 2.5 GHz
 $F=2.5\text{ GHz}$, 802.16-2004 OFDM, P/A=9.8 dB



Note: Under 802.16-2004 OFDM, 3.5 MHz Channel BW, 1/4 Cyclic Prefix, 64 QAM Modulated Burst, Symbol Length of 59, Coding Type RS-CC, Coding Rate Type 2/3.

Simulated Maximum Available Gain and K Factor of the CGH27015F

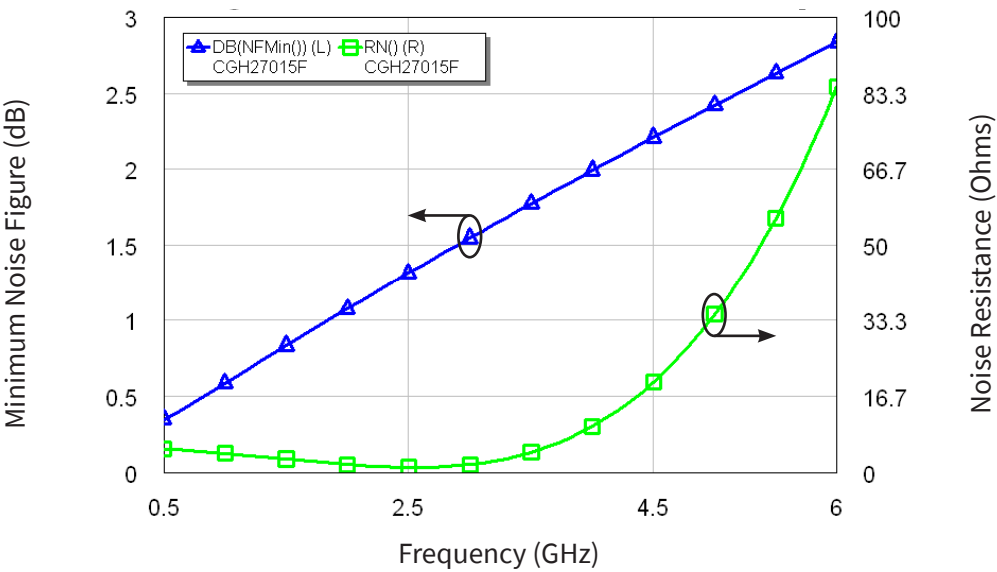
$$V_{DD} = 28\text{ V}, I_{DQ} = 100\text{ mA}$$





Typical Noise Performance

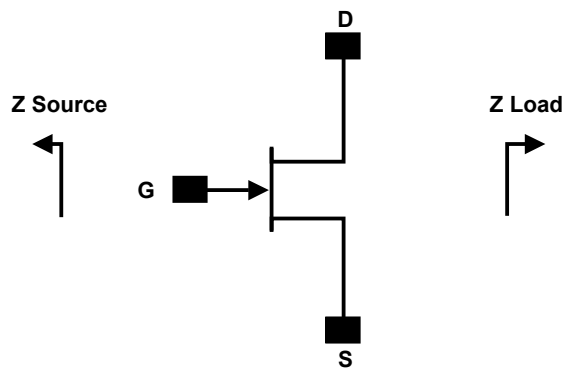
Simulated Minimum Noise Figure and Noise Resistance vs Frequency of the CGH27015
 $V_{DD} = 28\text{ V}$, $I_{DQ} = 100\text{ mA}$



Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	II (200 < 500 V)	JEDEC JESD22 C101-C

Source and Load Impedances

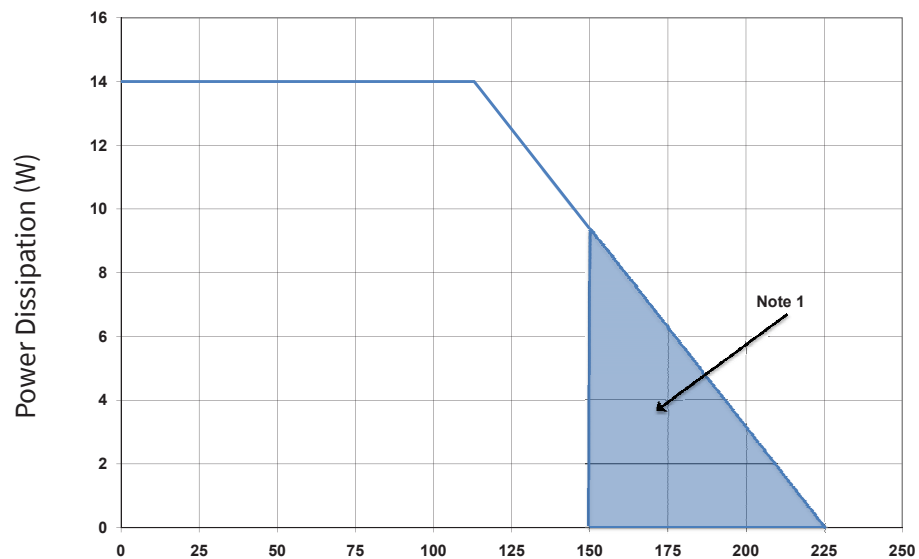


Frequency	Z Source	Z Load
2300	17.8 - j1.5	16.8 - j1.7
2400	20.3 - j4.0	16.9 - j0.8
2500	20.6 - j7.9	17.2 + j0.2
2600	18.2 - j11.3	17.7 + j1.3
2700	14.6 - j12.6	19.1 + j2.4

Note¹. $V_{DD} = 28V$, $I_{DQ} = 200mA$ in the 440166 package

Note². Impedances are extracted from the CGH27015-AMP demonstration amplifier and are not source and load pull data derived from the transistor

CGH27015 Power Dissipation De-rating Curve

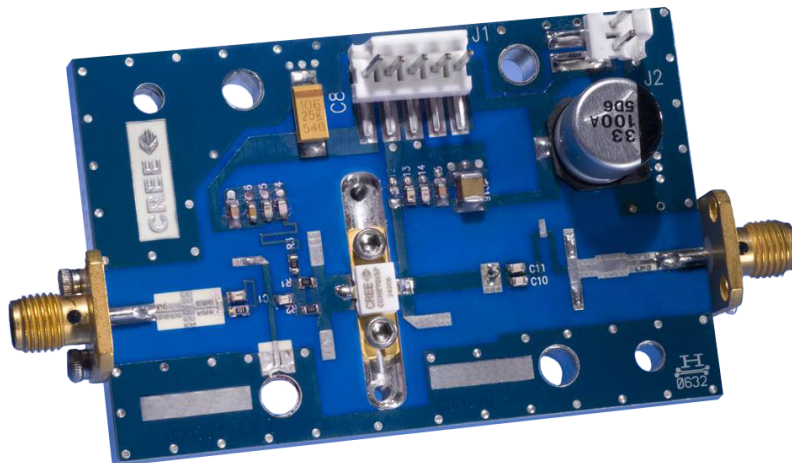


Note 1. Area exceeds Maximum Case Operating Temperature (See Page 2).

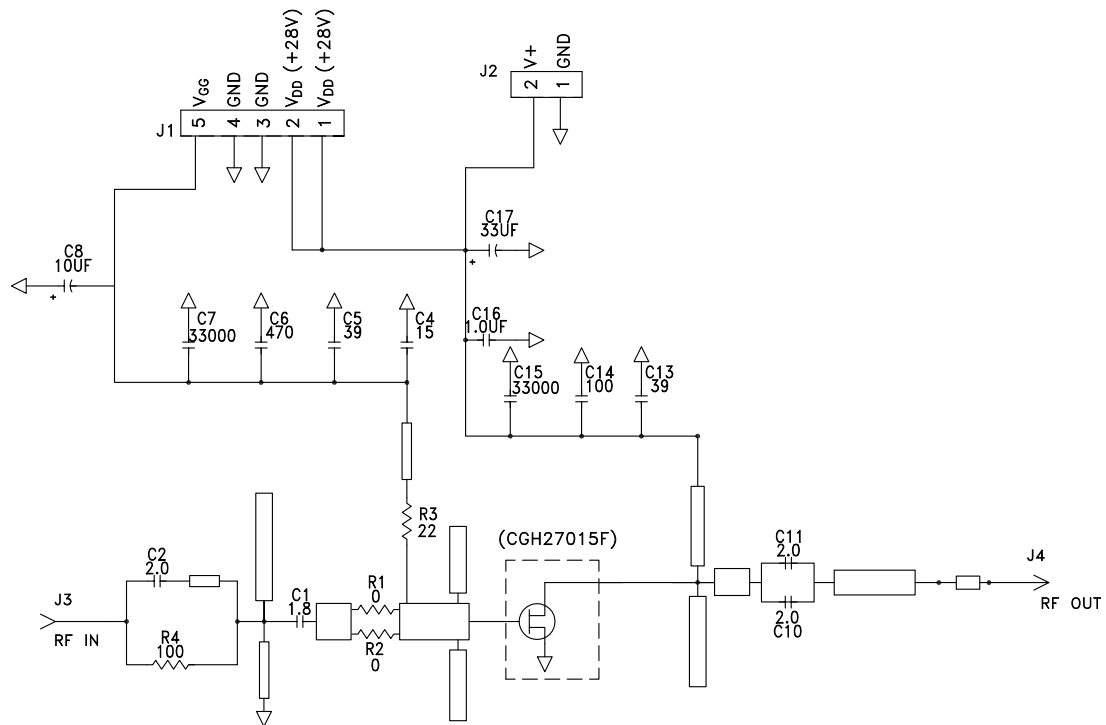
CGH27015-AMP Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
R1, R2	RES,1/16W,0603,1%,0 OHMS	2
R4	RES,1/16W,0603,1%,100 OHMS	1
R3	RES,1/16W,0603,1%,22.6 OHMS	1
C6	CAP, 470PF, 5%,100V, 0603	1
C17	CAP, 33 UF, 20%, G CASE	1
C16	CAP, 1.0UF, 100V, 10%, X7R, 1210	1
C8	CAP 10UF 16V TANTALUM	1
C14	CAP, 100.0pF, +/-5%, 0603	1
C4	CAP, 15pF, +/-5%, 0603	1
C1	CAP, 1.8pF, +/-0.1pF, 0603	1
C2, C10, C11	CAP, 2.0pF, +/-0.1pF, 0603	3
C5, C13	CAP, 39pF, +/-5%, 0603	2
C7, C15	CAP,33000PF, 0805,100V, X7R	2
J3, J4	CONN SMA STR PANEL JACK RECP	1
J2	HEADER RT>PLZ.1CEN LK 2 POS	1
J1	HEADER RT>PLZ .1CEN LK 5POS	1
-	PCB, RO4350B, Er = 3.48, h = 20 mil	1
-	CGH27015F or CGH27015P	1

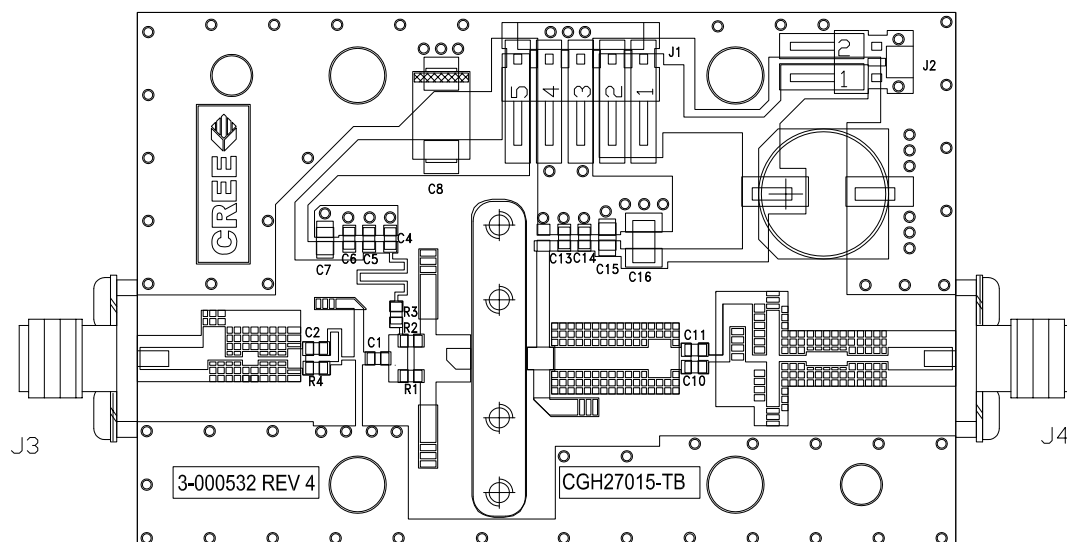
CGH27015-AMP Demonstration Amplifier Circuit



CGH27015-AMP Demonstration Amplifier Circuit Schematic



CGH27015-AMP Demonstration Amplifier Circuit Outline



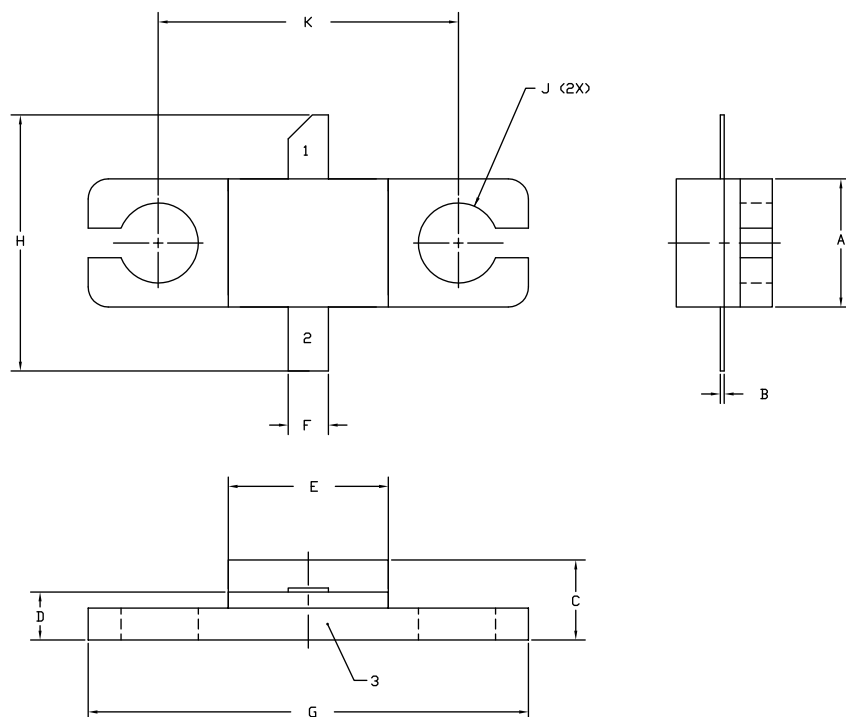


Typical Package S-Parameters for CGH27015
 (Small Signal, $V_{DS} = 28\text{ V}$, $I_{DQ} = 100\text{ mA}$, angle in degrees)

Frequency	Mag S11	Ang S11	Mag S21	Ang S21	Mag S12	Ang S12	Mag S22	Ang S22
500 MHz	0.909	-124.41	17.41	107.81	0.026	21.06	0.335	-93.73
600 MHz	0.902	-134.04	15.04	101.48	0.027	15.39	0.322	-101.61
700 MHz	0.898	-141.62	13.18	96.16	0.028	10.74	0.315	-107.78
800 MHz	0.894	-147.78	11.71	91.54	0.028	6.79	0.312	-112.73
900 MHz	0.892	-152.91	10.51	87.43	0.028	3.35	0.312	-116.77
1.0 GHz	0.890	-157.30	9.53	83.68	0.028	0.28	0.314	-120.15
1.1 GHz	0.889	-161.12	8.71	80.20	0.028	-2.51	0.318	-123.04
1.2 GHz	0.889	-164.51	8.01	76.95	0.028	-5.07	0.322	-125.57
1.3 GHz	0.888	-167.56	7.41	73.86	0.028	-7.45	0.328	-127.82
1.4 GHz	0.888	-170.34	6.89	70.91	0.028	-9.69	0.335	-129.87
1.5 GHz	0.888	-172.91	6.44	68.07	0.028	-11.81	0.342	-131.77
1.6 GHz	0.888	-175.30	6.04	65.32	0.028	-13.82	0.349	-133.56
1.7 GHz	0.888	-177.55	5.69	62.65	0.027	-15.74	0.357	-135.25
1.8 GHz	0.888	-179.68	5.37	60.05	0.027	-17.58	0.364	-136.89
1.9 GHz	0.888	-178.29	5.09	57.50	0.027	-19.34	0.373	-138.48
2.0 GHz	0.888	-176.34	4.83	55.01	0.027	-21.04	0.381	-140.03
2.1 GHz	0.889	-174.45	4.60	52.56	0.026	-22.69	0.389	-141.55
2.2 GHz	0.889	-172.63	4.39	50.14	0.026	-24.27	0.397	-143.06
2.3 GHz	0.889	-170.84	4.20	47.76	0.026	-25.80	0.405	-144.56
2.4 GHz	0.889	-169.10	4.02	45.41	0.025	-27.28	0.413	-146.04
2.5 GHz	0.890	-167.39	3.86	43.09	0.025	-28.70	0.421	-147.52
2.6 GHz	0.890	-165.71	3.71	40.79	0.025	-30.08	0.429	-149.00
2.7 GHz	0.891	-164.04	3.57	38.51	0.024	-31.41	0.437	-150.48
2.8 GHz	0.891	-162.39	3.44	36.26	0.024	-32.69	0.445	-151.95
2.9 GHz	0.891	-160.76	3.32	34.01	0.024	-33.92	0.452	-153.43
3.0 GHz	0.892	-159.13	3.21	31.79	0.023	-35.10	0.459	-154.92
3.2 GHz	0.892	-155.89	3.00	27.38	0.023	-37.31	0.473	-157.90
3.4 GHz	0.893	-152.65	2.83	23.00	0.022	-39.32	0.486	-160.90
3.6 GHz	0.893	-149.39	2.67	18.66	0.021	-41.09	0.499	-163.93
3.8 GHz	0.894	-146.09	2.54	14.34	0.020	-42.63	0.510	-166.99
4.0 GHz	0.894	-142.74	2.41	10.02	0.020	-43.90	0.521	-170.10
4.2 GHz	0.895	-139.33	2.31	5.70	0.019	-44.88	0.530	-173.24
4.4 GHz	0.895	-135.84	2.21	1.37	0.018	-45.53	0.539	-176.45
4.6 GHz	0.895	-132.26	2.12	-2.98	0.018	-45.84	0.547	-179.71
4.8 GHz	0.895	-128.59	2.04	-7.36	0.017	-45.78	0.554	-176.97
5.0 GHz	0.895	-124.80	1.97	-11.79	0.016	-45.32	0.561	-173.56
5.2 GHz	0.895	-120.90	1.91	-16.27	0.016	-44.47	0.566	-170.07
5.4 GHz	0.895	-116.87	1.85	-20.81	0.016	-43.25	0.571	-166.48
5.6 GHz	0.895	-112.70	1.80	-25.41	0.015	-41.72	0.575	-162.78
5.8 GHz	0.895	-108.38	1.75	-30.10	0.015	-39.97	0.579	-158.96
6.0 GHz	0.895	-103.92	1.70	-34.88	0.016	-38.13	0.581	-155.00

To download the s-parameters in s2p format, go to the [CGH27015](#) Product page and click on the documentation tab.

Product Dimensions CGH27015F (Package Type — 440166)



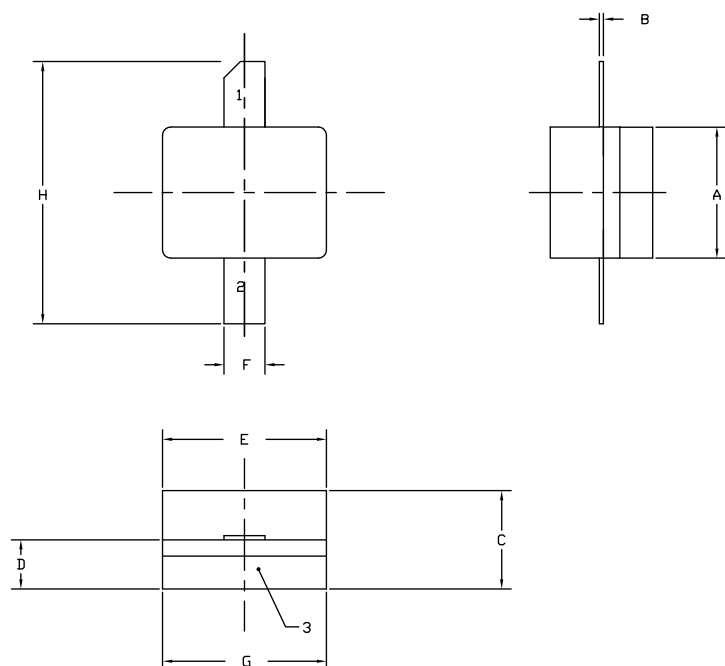
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
5. ALL PLATED SURFACES ARE NI/AU.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.155	0.165	3.94	4.19
B	0.004	0.006	0.10	0.15
C	0.115	0.135	2.92	3.43
D	0.057	0.067	1.45	1.70
E	0.195	0.205	4.95	5.21
F	0.045	0.055	1.14	1.40
G	0.545	0.555	13.84	14.09
H	0.280	0.360	7.11	9.14
J	Ø .100		2.54	
K	0.375		9.53	

PIN 1. GATE
PIN 2. DRAIN
PIN 3. SOURCE

Product Dimensions CGH27015P (Package Type — 440196)



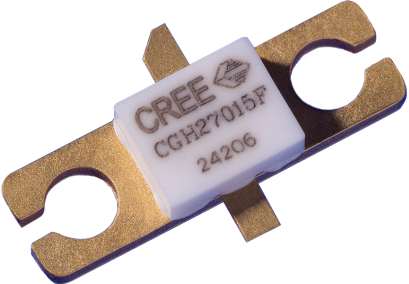
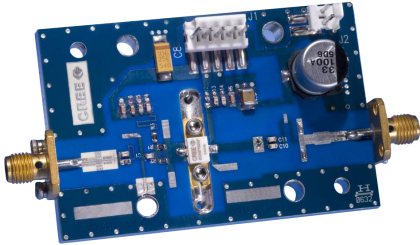
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DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.155	0.165	3.94	4.19
B	0.003	0.006	0.10	0.15
C	0.115	0.135	2.92	3.17
D	0.057	0.067	1.45	1.70
E	0.195	0.205	4.95	5.21
F	0.045	0.055	1.14	1.40
G	0.195	0.205	4.95	5.21
H	0.280	0.360	7.11	9.14

PIN 1. GATE
PIN 2. DRAIN
PIN 3. SOURCE

Product Ordering Information

Order Number	Description	Unit of Measure	Image
CGH27015F	GaN HEMT	Each	
CGH27015P	GaN HEMT	Each	
CGH27015F-AMP	Test board with GaN HEMT installed	Each	

For more information, please contact:

4600 Silicon Drive
Durham, North Carolina, USA 27703
www.wolfspeed.com/RF

Sales Contact
RFSales@cree.com

Notes

Disclaimer

Specifications are subject to change without notice. “Typical” parameters are the average values expected by Cree in large quantities and are provided for information purposes only. Cree products are not warranted or authorized for use as critical components in medical, life-saving, or life-sustaining applications, or other applications where a failure would reasonably be expected to cause severe personal injury or death. No responsibility is assumed by Cree for any infringement of patents or other rights of third parties which may result from use of the information contained herein. No license is granted by implication or otherwise under any patent or patent rights of Cree.